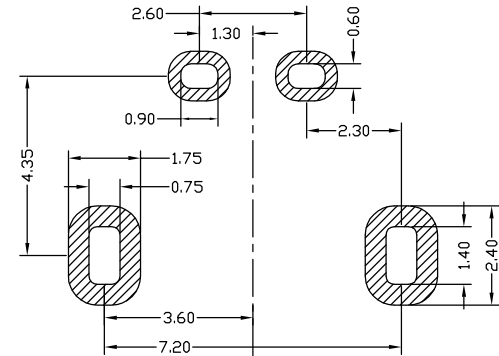
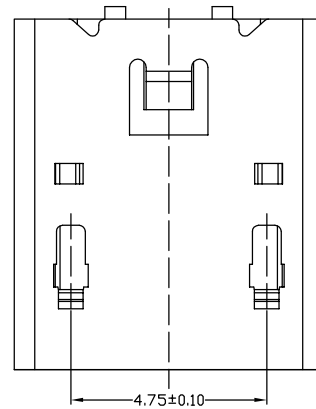
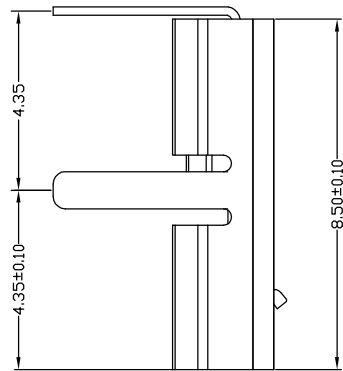
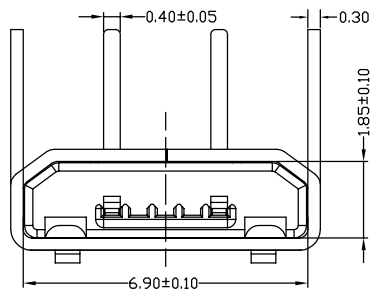
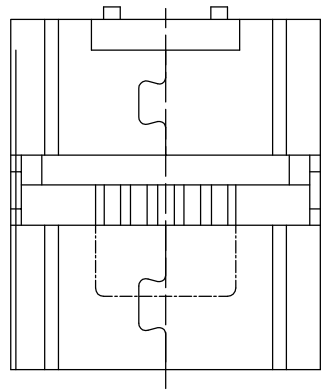
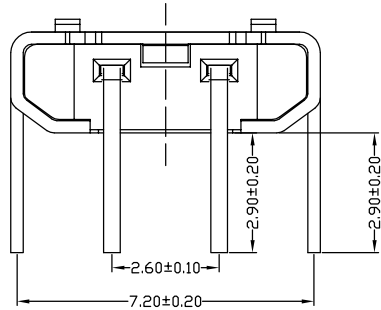


The product using material and processing must conform to the "WL-PZ-001"HSF technical standard control requirements

RoHS



PCB LAYOUT

NOTE:

- 1.MATERIAL SPECIFICATION:
 - 1-1.HOUSING:LCP BLACK UL94V-0
 - 1-2.CONTACTS:COPPER ALLOY
 - 1-3.SHELL: SPCC.
- 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS:
 - Ni 50u" MIN. UNDER PLATED OVER ALL.
 - Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - 2-2. SHELL:
 - Ni 30u" MIN. UNDER PLATED OVER ALL.
- 3.MECHANICAL PERFORMANCE:
 - 3-1.INSERTION FORCE: 3.57kgf MAX
 - 3-2.REMOVAL FORCE: 0.8kgf MIN
 - 3-3.DURABILITY: 10000 CYCLES.
- 4.ELECTRICAL PERFORMANCE:
 - 4-1.CURRENT RATING:1.5A
 - 4-2.VOLTAGE RATING:5V MAX
 - 4-3.CONTACT RESISTANCE: 30m Ohm MAX.
 - 4-4.INSULATION RESISTANCE: 100MΩ MIN
 - 4-5.DIELECTRIC WITHSTANDING VOLTAGE: 100V AC MIN
- 5.ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -30°C~+85°C.
 - PACKAGE SPEC:TUBE

PART NO.:

WLM2F9-02 1 X X X 026

PLATING:

- 1-G/F
- 2-Au 3u"
- 5-Au 15u"
- 6-Au 30u"

SHELL:

9-NI

COLOUR:

A-BLACK

REV.	REVISION RECORD	DATE	UNIT:mm	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:	TITLE:	REV: A0	SHEET: 1/1
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	1:1							
				0.0±0.35	X'REF±6'	APPROVED	Wang_jr	21.01.13	WLM2F9-021XXX026	ENDE05	MICRO 5P/F B TYPE 2P DIP 7.2(2.9*0.9)		
				0.00±0.25	X'±3'	DESIGNER	Ding_bo	21.01.13					
				0.000±0.10	X'X' ±2'	DRAWN	Ou_jian	21.01.13					

